## CMOS 4-bit 1 Chip Microcomputer — EPROM equipped

Description

The CXP50200 is a CMOS 4-bit microcomputer common with piggyback/evaulation chip which are developed for CXP50212/CXP50216 function evaluation.

Features

- Instruction cycle   1.9μs/4.19 MHz
- ROM capacity   Maximum 32k bytes
  (EPROM 27C256 equipped)
- RAM capacity   544×4 bits
  (Including display area)
- 40 general purpose I/O ports
- 8 high current ports (Ports C, D)
- Fluorescent display panel controller/driver
  (Ables to display maximum 256 segments)
  —1 to 16 digits dynamic scan display
                 (1 to 8 digits at 24 segments)
  —Page mode/variable mode
  —Dimmer function
  —High tension proof output (40 V)
  —Selection possible for incorporating pull-down resistance (mask option)
- 14-bit PWM output for D/A conversion
- Remote control receiving circuit (Be independent of the timer/counter)
- 3-bit A/D converter (1 channel per circuit)
- 8-bit/4-bit variable prescaler serial I/O
- 8-bit prescaler timer, 8-bit prescaler timer/event counter, 18-bit time base timer and 8-bit reload type timer with prescaler, independently controlled


64pin SDIP (Ceramic)
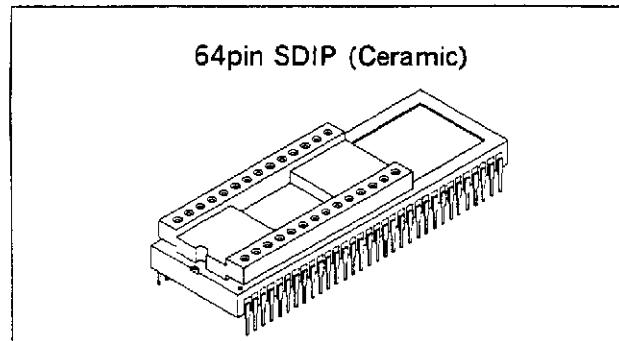
- Arithmetic and logical operations possible between the entire ROM area, I/O area and the accumulator by means of memory mapped I/O
- Reference to the entire ROM area is possible with the table look-up instruction
- 2 kinds of power down modes, sleep and stop
- Power on reset circuit (mask option)
- Provided with 64 pin ceramic SDIP

Note) The mask option is fixed according to a kind of CXP50200.
   See the List of Products for details.

Structure

Silicon gate CMOS IC

Block Diagram

Common with
A/D converter
analog input

(Input and output is
possible)

(Input and output is
possible by port unit)

Common with
segment output
S4 to S7

Common with
segment output
S0 to S3

| Port B | Port C | Port D | Port E | Port F | Port G | Port H |

Register

Data memory

448 ×
4
bits

Data memory

Data memory

64 × 4
bits

Stack

Display memory
96 × 4 bits

Fluorescent
display panel
controller/
driver

VFDP

ALU

Accumulator

Flag

Timer (8)

Timer/Counter (8)

Serial I/O (8)

Interrupt control

Timer (8)

PWM (14)

A/D Converter

Remote control
receive

Program
counter (14)

Address buffer

A0~A14

I0~I7

Instruction
input buffer

Instruction control

Time base timer
(18)

Clock control

Port J — Common
with segment
output S12
to S15

Port K — Common
with segment
output S8 to
S11

EXTAL

XTAL

S0 – S7

S8 – S15

S16/T15 – S23/T8

T0 – T7

Common with
PG, PH, PJ, PK

Port X

PX2/SI

PX1/SO

PX0/SC

(Common with serial I/O)

Port Y

RMC/PY3

PY2/WP

PY1/PWM

PY0

EC

INT

VDD

VSS

RST

Pin Configuration (Top View)

Left pins		Inner left		Inner right		Right pins
T1	①	① VDD	㉘ VDD		㉞	VDD
T0	②	② A12	㉗ A14		㉓	T2
INT	③	③ A7	㉖ A13		㉒	T3
RST	④	④ A6	㉕ A8		㉑	T4
ADI/PB3	⑤	⑤ A5	㉔ A9		⑥⓪	T5
EC	⑥	⑥ A4	㉓ A11		㉟	T6
SC/PX0	⑦	⑦ A3	㉒ Vss		㉘	T7
S0/PX1	⑧	⑧ A2	㉑ A10		㊲	S23/T8
S1/PX2	⑨	⑨ A1	⑳ Vss		㊱	S22/T9
PF0	⑩	⑩ A0	⑲ I7		㉟	S21/T10
PF1	⑪	⑪ I0	⑱ I6		㊴	S20/T11
PF2	⑫	⑫ I1	⑰ I5		㉝	S19/T12
PF3	⑬	⑬ I2	⑯ I4		㉜	S18/T13
PE0	⑭	⑭ Vss	⑮ I3		㉛	S17/T14
PE1	⑮				㊿	S16/T15
PE2	⑯				㊾	PJ3/S15
PE3	⑰				㊽	PJ2/S14
PY0	⑱				㊼	PJ1/S13
PWM/PY1	⑲				㊻	PJ0/S12
WP/PY2	⑳				㊺	PK3/S11
RMC/PY3	㉑				㊹	PK2/S10
PD0	㉒				㊸	PK1/S9
PD1	㉓				㊷	PK0/S8
PD2	㉔				㊶	PG3/S7
PD3	㉕				㊵	PG2/S6
PC0	㉖				㊴	PG1/S5
PC1	㉗				㊳	PG0/S4
PC2	㉘				㊲	PH3/S3
PC3	㉙				㊱	PH2/S2
XTAL	㉚				㉟	PH1/S1
EXTAL	㉛				㉞	PH0/S0
Vss	㉜				㉝	VFDP

Note) Use 27C256 type for EPROM.

Pin Description

Symbol	Name	I/O	Description	Equivalent circuit
V_{DD}	Supply voltage	I	Positive voltage supply pin	
V_{SS}	Grounding voltage	I	GND pin	
EXTAL	Clock input	I	Clock oscillation circuit input pin. Connect the crystal oscillator or ceramic oscillator between the EXTAL and XTAL. To use an external clock input, connect the clock oscillation source to the EXTAL pin and open the XTAL pin.	EXTAL, XTAL
XTAL	Clock output	O	Clock oscillation circuit output pin	
$\overline{RST}$	Reset	I/O	Serves as the incorporated power on reset circuit output pin. When inputting a reset signal from the outside, provide 2 instruction cycles or longer of an "L" level (0 V).	Mask option Output pull-up resistor (P-ch Tr) N-ch Tr output Schmitt inverter input
INT	External interrupt	I	Serves as interrupt input pin. Permits the selection with a program of the edge and the level modes.	Schmitt inverter input
$\overline{EC}$	Event counter input	I	Event counter input pin.	
SI/PX2	Serial input Port X	I	Combination pin of a serial interface (8 bits) input pin and bit "2" (input) of port X.	
SO/PX1	Serial input Port X	I/O	Combination pin of a serial interface (8 bits) output pin and bit "1" (input) of port X.	Data, disable 3-state output or pull-up resistor output possible Inverter input
$\overline{SC}$/PX0	Serial clock Port X	I/O	Combination pin of clock input/output pin for the serial interface and bit "0" (input) of port X.	Data, disable 3-state output or pull-up resistor output possible Inverter input
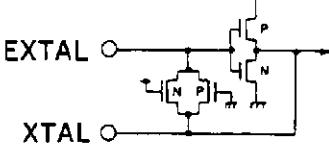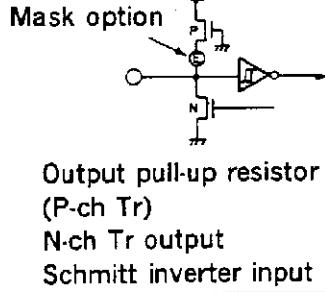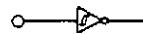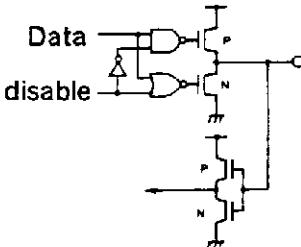
Symbol	Name	I/O	Description	Equivalent circuit
RMC/PY3	Remote control signal input Port Y	I	Combination pin of remote control receiver input pin and bit "3" (input) of port Y.	Schmitt inverter input
WP/PY2	Wake-up input Port Y	I	Combination pin of a wake-up input pin to release the standby state and bit "2" (input) of port Y.	
PWM/PY1	PWM output Port Y	O	Combination pin of a PWM generator (14 bits) output and bit "1" (output) of port Y.	Data —▷o—[ ]—o (When reset: 1)
PY0	Port Y	O	Output pin for bit "0" of port Y.	Inverter output
PB3/ADI	Analog input Port B	I/O	This 1-bit input/output port permits its each individual port to be programmed to serve for input or output. Its output format is a 3-state or pull-up resistor output. It is also used for A/D converter input.	Data disable 3-state output or pull-up resistor output possible Inverter input
PC to PC3	Port C	I/O	This 4-bit input/output port permits its each individual port to be programmed to serve for input or output. Its output format is a 3-state or pull-up resistor output.	
PD0 to PD3	Port D	I/O	The same as port C.	
PE0 to PE3	Port E	I/O	The same as port C.	
PF0 to PF3	Port F	I/O	The same as port C.	
V_{FDP}	Power supply for FDP	I	Load current supply pin needed when load resistance is built in to output driver for FDP (Fluorescent Display Panel).	
T0 to T7	Timing	O	Lower 8-digit output pin of the FDP timing signal.	
T8/S23 to T15/S16	Timing/segment	O	Combination output pin of higher 8-digit of the FDP timing signal and the segment signal.	P-ch open drain outut Pull-down resistance (Mask option)
PG0/S4 to PG3/S7	Port G/segment	O	Combination pin of the 4-bit output port and FDP segment signal ouput.	
PH0/S0 to PH3/S3	Port H/segment	O	The same as port G.	
PJ0/S12 to PJ3/S15	Port J/segment	O	The same as port G.	
PK0/S8 to PK3/S11	Port K/segment	O	The same as port G.	
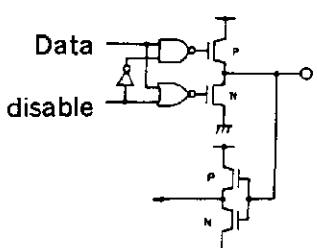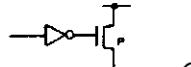
Absolute Maximum Ratings (Ta = −20°C to +75°C, V_{SS} = 0 V)

Item	Symbol	Ratings	Unit	Remarks
Power supply voltage	V_{DD}	−0.3 to +7.0	V	
Input voltage	V_{IN}	−0.3 to +7.0*¹	V	
Output voltage	V_{OUT}	−0.3 to +7.0*¹	V	
Display output voltage	V_{OD}	V_{DD}−40 to V_{DD}+0.3	V	As P channel transistor is open drain, V_{DD} voltage is determined as standard.
High level output current	I_{OH}	−5	mA	Other than display output pin*²: per pin
	I_{ODH1}	−15	mA	Display output S0 to S15: per pin
	I_{ODH2}	−35	mA	Display output T0 to T7, T8/S23 to T15/S16: per pin
High level total output current	ΣI_{OH}	−40	mA	Total of other than display output pins
	ΣI_{ODH}	−100	mA	Total of display output pins
Low level output current	I_{OL}	15	mA	Port 1 pin
	I_{OLC}	20	mA	High current port 1 pin*³
Low level total output current	ΣI_{OL}	100	mA	Entire pin total
Operating temperature	T_{opr}	−20 to +75	°C	
Storage temperature	T_{stg}	−55 to +150	°C	
Allowable power dissipation*⁴	P_D	600	mW	

*1) V_{IN} and V_{OUT} should not exceed V_{DD}+0.3V.
*2) Specifies the output current of PB to PF, S0, $\overline{SC}$ (the general purpose I/O ports) and PY0, PY1 (Output ports).
*3) The high current drive transistors are the N channel transistors of the PC and PD ports.
*4) Allowable power dissipation of EPROM excluded.
Note) Usage exceeding absolute maximum ratings may permanently impair the LSI. Normal operation should better take place under the recommended operating conditions. Exceeding those conditions may adversely affect the reliability of the LSI.

Recommended Operating Conditions (V_{SS} = 0 V)

Item	Symbol	Min.	Max.	Unit	Remarks
Power supply voltage	V_{DD}	4.5	5.5	V	Guarateed range of operation by EXTAL clock
		2.5	5.5	V	Guranteed range of data hold during STOP
High level input voltage	V_{IH}	$0.7V_{DD}$	V_{DD}	V	
	V_{IHS}	$0.8V_{DD}$	V_{DD}	V	Hysteresis input*¹
	V_{IHEX}	V_{DD}−0.4	V_{DD}+0.3	V	EXTAL pin*²
Low level input voltage	V_{IL}	0	$0.3V_{DD}$	V	
	V_{ILS}	0	$0.2V_{DD}$	V	Hysteresis input*¹
	V_{ILEX}	−0.3	0.4	V	EXTAL pin*²
Operating temperature	T_{opr}	−20	+75	°C	

*1) Each of INT, $\overline{EC}$, PX0, PX2, PY2, PY3 and $\overline{RST}$ pin.
*2) Spcified only during external clock input.

Electrical Characteristics
DC characteristics (Ta$=-20°$C to $+75°$C, $V_{SS}=0$ V)

Item	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
High level output voltage	V_{OH}	PB to PF, PXO, PX1	$V_{DD}=4.5V$, $I_{OH}=-0.5mA$	4.0			V
			$V_{DD}=4.5V$, $I_{OH}=-1.0mA$	3.5			V
Low level output voltage	V_{OL}	PYO, PY1 $\overline{RST}$ (V_{OL} only)	$V_{DD}=4.5V$, $I_{OL}=1.8mA$			0.4	V
			$V_{DD}=4.5V$, $I_{OL}=3.6mA$			0.6	V
		PC, PD	$V_{DD}=4.5V$, $I_{OL}=12mA$			1.5	V
Input current	I_{IHE}	EXTAL	$V_{DD}=5.5V$, $V_{IH}=5.5V$	0.5		40	μA
	I_{ILE}		$V_{DD}=5.5V$, $V_{IL}=0.4V$	-0.5		-40	μA
	I_{ILR}	$\overline{RST}$*2	$V_{DD}=5.5V$, $V_{IL}=0.4V$	-1.5		-400	μA
Display output current	I_{OH}	SO to S15	$V_{DD}=4.5V$ $V_{OH}=V_{DD}-2.5V$	-7			mA
		S16/T15 to S23/T8 TO to T7		-18			mA
Open drain output leakage current (P-CH Tr OFF in state)	I_{LOL}	SO to S15 S16/T15 to S23/T8 TO to T7	$V_{DD}=5.5V$ $V_{OL}=V_{DD}-35V$			-20	μA
Pull-down resistance*1	R_L	SO to S15 S16/T15 to S23/T8 TO to T7	$V_{DD}=5V$ $V_{FDP}=V_{DD}-35V$	60	100	270	$k\Omega$
High impedance I/O leakage current	I_{IZ}	PB to PF, PXO to PX2, PY2, PY3, $\overline{EC}$ INT, $\overline{RST}$*2	$V_{DD}=5.5V$ $V_I=0, 5.5V$			±10	μA
Current supply*3	I_{DD}	V_{DD}	$V_{DD}=5.5V$, 4.19MHz crystal oscillation (C1=C2=22pF) Entire output pins open		7	20	mA
	I_{DDSP}		SLEEP mode		5	12	mA
	I_{DDS}		STOP mode			10	μA
Input capacity	C_{IN}	PB to PF, PX PY2, PY3, EXTAL, $\overline{RST}$, INT, $\overline{EC}$	fc=1MHz OV other than the measured pins		10	20	pF

*1) In case the incorporated pull-down resistance has been selected with mask option.
*2) $\overline{RST}$ pin specifies the input current when the pull-up resistance is selected, and specifies leakage current when nonresistance is selected.
*3) Current supply of EPROM excluded.

AC characteristics

(1) Clock timing (Ta=−20℃ to +75℃, V_{DD}=4.5 V to 5.5 V, V_{SS}=0 V)

Item	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
System clock frequency	f_c	XTAL EXTAL	Fig. 1, Fig. 2	1		5	MHz
System clock input pulse width	t_{XL} t_{XH}	EXTAL	Fig. 1, Fig. 2 External clock drive	90			ns
System clock input rising and falling times	t_{CR} t_{CF}	EXTAL	Fig.1, Fig.2 External clock drive			200	ns
Event count clock input pulse width	t_{EL} t_{EH}	$\overline{EC}$	Fig. 3	tsys[1] +0.05			μs
Event count clock input rising and falling times	t_{ER} t_{EF}	$\overline{EC}$	Fig. 3			20	ms

*1) tsys is tsys $= 8/f_c$
*2) Specified when the crystal oscillation mode is selected by the mask option.
Note) When adjusting the frequency accurately, there may be cases in which they may differ from Fig. 2.

Fig. 1 Clock timing
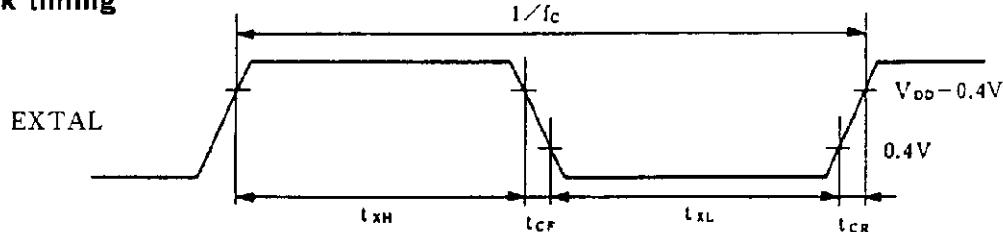
Fig. 2 Clock applying condition
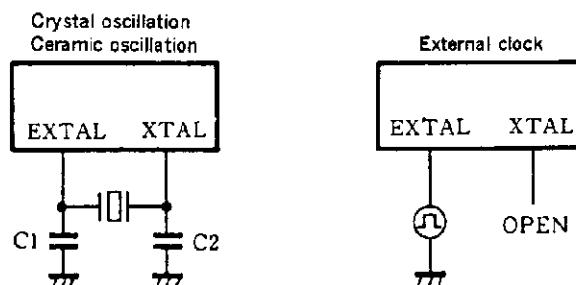
Fig. 3 Event count clock timing
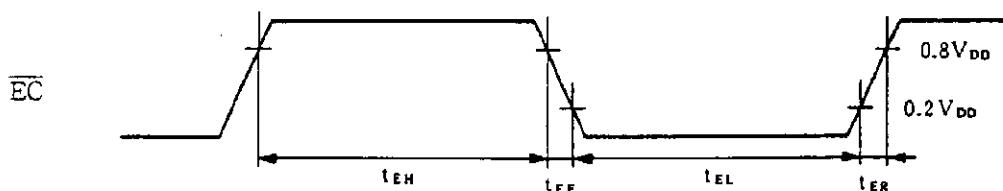
(2) Serial transfer (Ta＝－20°C to ＋75°C, V_{DD}＝4.5 V to 5.5 V, V_{SS}＝ 0V)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
Serial transfer clock ($\overline{SC}$) cycle time	t_{KCY}	$\overline{SC}$	Input mode	tsys/4＋1.42		μs
			Output mode	t_{SIO}		μs
Serial transfer clock ($\overline{SC}$) high and low level widths	t_{KH} t_{KL}	$\overline{SC}$	Input mode	tsys/8＋0.7		μs
			Output mode	t_{SIO}/2－0.1		μs
Serial data input setup time (against $\overline{SC}$ ↑)	t_{SIK}	SI	$\overline{SC}$ input mode	0.1		μs
			$\overline{SC}$ output mode	0.2		μs
Serial data input hold time (against $\overline{SC}$ ↑)	t_{KSI}	SI	$\overline{SC}$ input mode	tsys/8＋0.5		μs
			$\overline{SC}$ output mode	0.1		μs
Data output delay time from $\overline{SC}$ falling	t_{KSO}	SO			tsys/8＋0.5	μs

Note 1) tsys is tsys ＝8/f_C
t_{SIO} is turned into either 2tsys, 4tsys or 16tsys by means of a program.
2) The load of data output delay time is 50 pF ＋1 TTL.

Fig. 4 Serial transfer timing
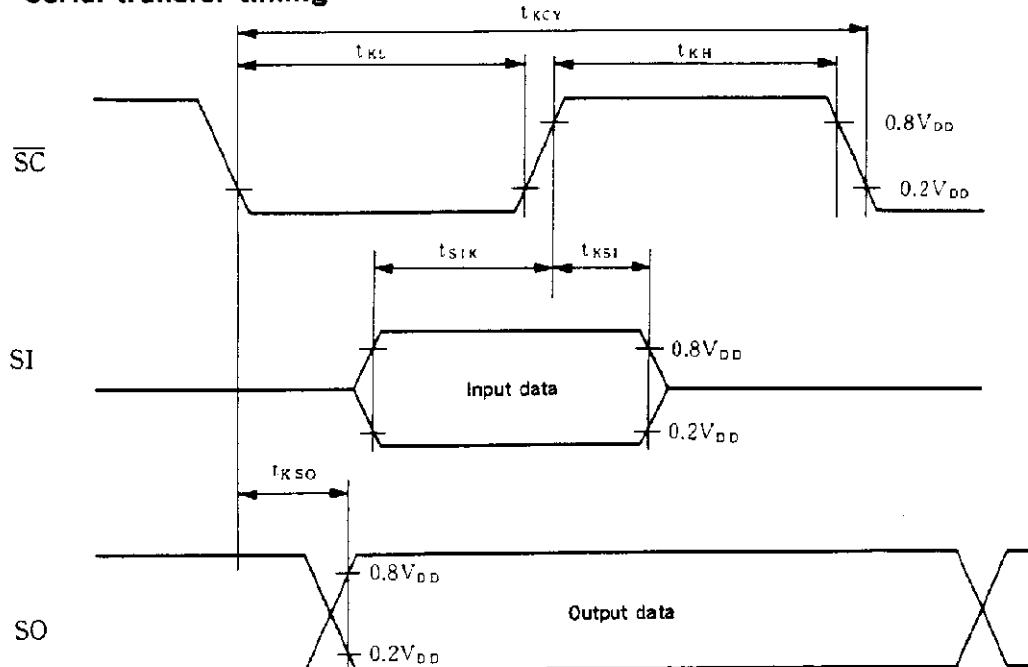
(3) A/D converter (Ta＝－20°C to ＋75°C, V_{SS} ＝ 0 V)

Analog input voltage	Pin	Condition	Digital conversion value
0.0 to 0.33V	ADI	V_{DD}＝5V	000
0.82 to 1.29V			001
1.78 to 2.21V			010
2.69 to 3.06V			011
3.56 to 4.06V			100
4.62 to 5.0V			101

Note) The digital conversion values are the values when FF_H address in the program are read.

(4) Others (Ta = −20°C to +75°C, V_{DD} = 4.5 V to 5.5 V, V_{SS} = 0 V)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
External interruption high and low level widths	t_{I1H}, t_{I1L}	INT	Edge detection mode	tsys+0.05		μs
Reset input low level width	t_{RSL}	$\overline{RST}$		2tsys		μs
Wake-up input high level width	t_{WPH}	WP	STOP mode	500		μs
			SLEEP mode	tsys+0.05		μs

Note) tsys is tsys = 8/f_c

Fig. 5 Interruption input timing

INT (Rising edge)

INT (Falling edge)
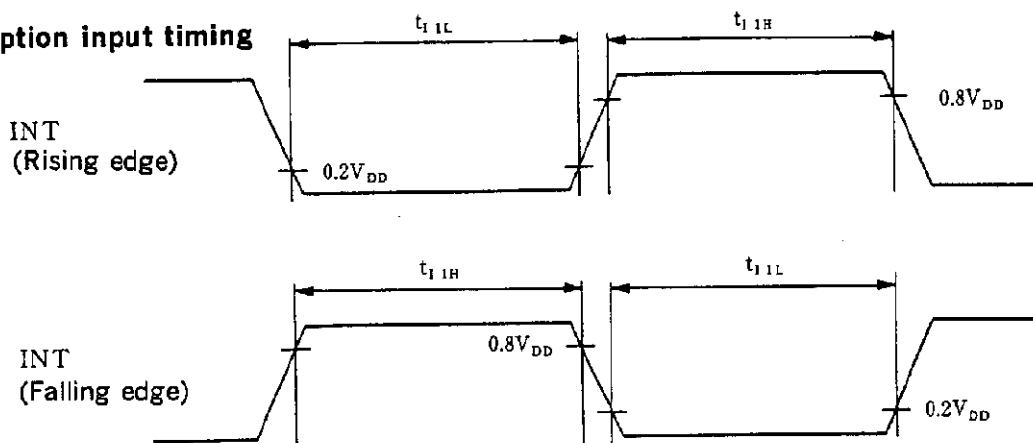
Fig. 6 $\overline{RST}$ input timing

$\overline{RST}$
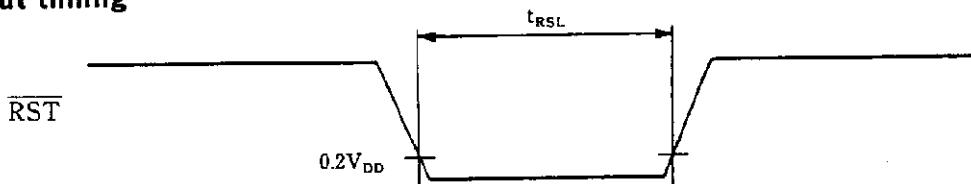
Fig. 7 Wake-up input timing

WP
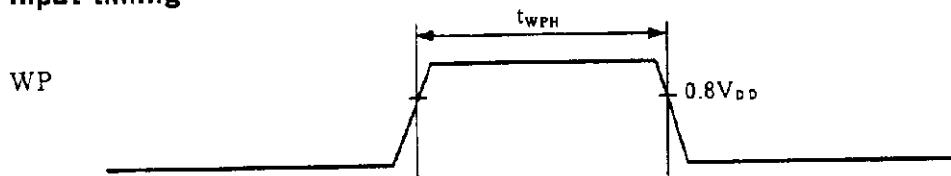
Power on reset* (Ta = −20°C to +75°C, V_{SS} = 0 V)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
Power supply rising time	t_R	V_{DD}	Power on reset	0.05	50	ms
Power supply cut-off time	t_{OFF}		Repetitive power on reset	1		ms

* Specifies only when power on reset function is selected.

### Fig. 8 Power on reset

V_{DD} 4.5V   0.2V

The power supply should rise smoothly.
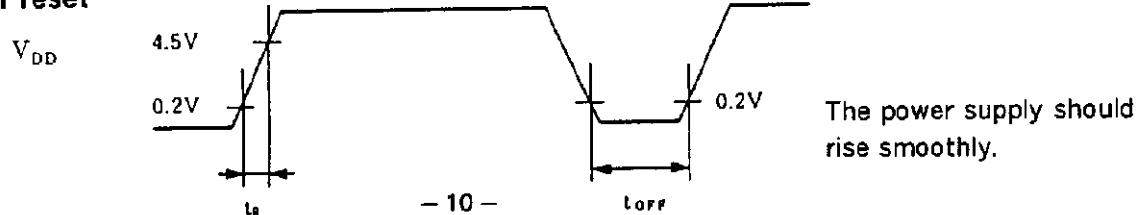
Notes on Operation

See Fig. 9, additive capacity calculation chart, when using the crystal oscillator and select the appropriate capacity.

Fig. 9 Crystal oscillation circuit additive capacity calculation chart
(Ta = −20 to +75°C, V_{DD} = 4.5 to 5.5 V)

f ·Crystal oscillation frequency (MHz)
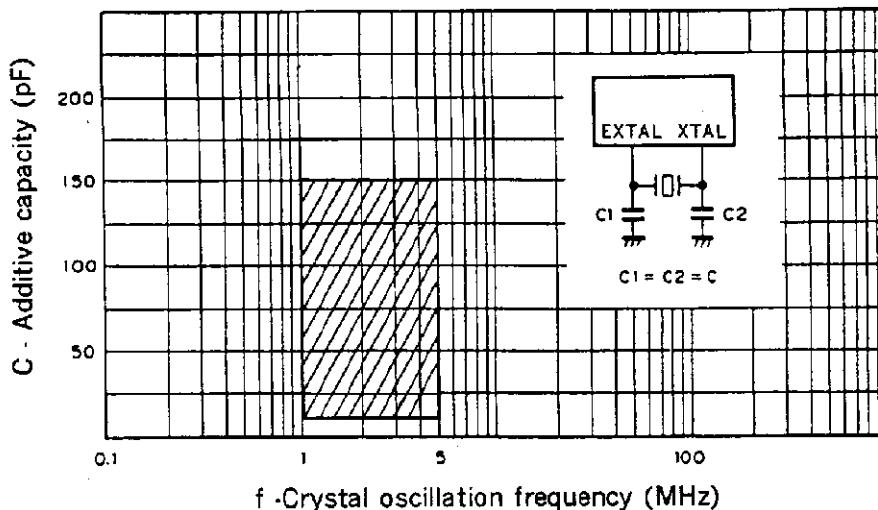
Note) The above chart shows a range in which the average quartz resonator has a relatively fast oscillation rising edge and stable characteristics. The capacity should be selected to correspond to the appropriate constant for each quartz resonator, should the frequency of the quartz resonator be accurately adjusted.

Fig. 10 shows recommended circuits and oscillators. Use the trimmer capacitor to C1, in the case of accurate adjustment of the oscillation frequency.

Fig. 10 Recommended oscillation circuit
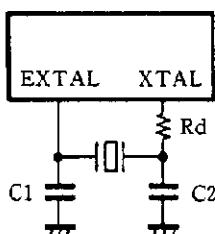
Manufacturer	Model	Frequency	C1	C2	Rd
MURATA MFG CO., LTD.	CSA4.19MG040	4.19 MHz	100pF	100pF	—
	CST4.19MGW040	4.19 MHz	— (built in)	— (built in)	—

Manufacturer	Model	Frequency	C1	C2	Rd
CITIZEN WATCH CO., LTD.	CSA-309	4.19 MHz	10pF (20pF trimmer)	10pF	—
NIHON DENPA KOGYO CO., LTD.	AT-51	4.19 MHz	15pF (20pF trimmer)	15pF	6.8kΩ
KINSEKI LTD.	HC-49/U-S	4.19 MHz	22pF	22pF	3.3kΩ

When using the A/D converter as the key input, it is recommended that the circuit structure shown in Fig. 11 be used.

### Fig. 11 Recommended example of key circuit by A/D converter
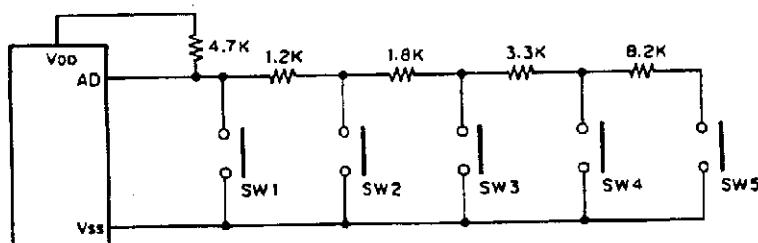
(Precision of resistance is all within ±5%)

EPROM Read Timing

Ta = −20°C to +75°C, V_{DD} = 4.5 V to 5.5 V, V_{SS} = 0 V

Item	Symbol	Pin	Min.	Max.	Unit
Address → Data input delay time	t_{ACC}	A0 to A14 I0 to I7		300	ns
Address → Data hold time	t_{IH}	A0 to A14 I0 to I7	0		ns

EPROM Timing
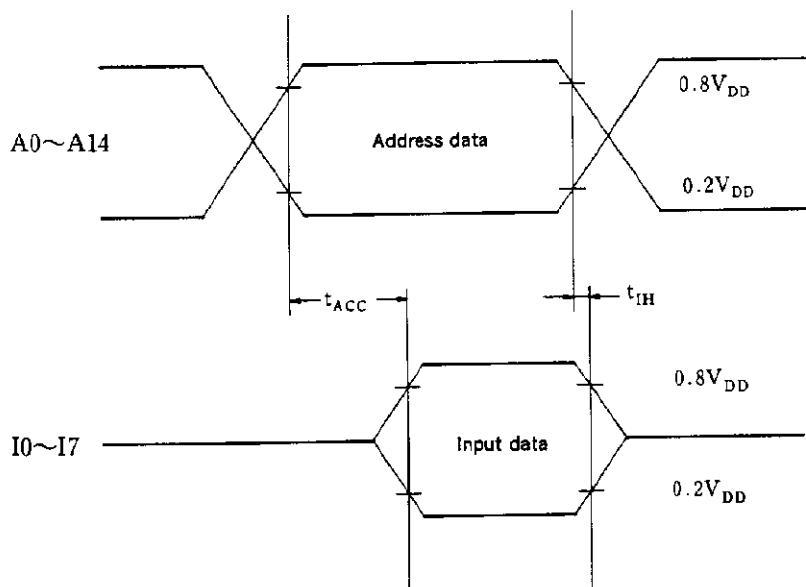
List of Products

Option item	Product	CXP50200-U01Q
Package	64-pin plastic SDIP	64-pin ceramic SDIP
ROM capacity	12k bytes/16k bytes	EPROM 32k bytes
Pull-up resistance of reset pin	Mask/Non-mask	Mask
Power on reset circuit	Mask/Non-mask	Mask
32kHz timer/counter	Timer/counter	Timer mode
High tension pull-down resistance	Mask/Non-mask	Non-mask

Note) Chip for both piggy and evaluation.

Package Outline   **Unit : mm**

64pin SDIP (Ceramic)

PSDIP-64C-01